FAIRCHILD SEMICONDUCTOR

20V N-Channel PowerTrench[®] MOSFET

General Description

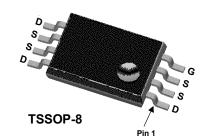
This N-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (2.5V to 8V).

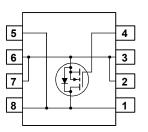
Applications

- Battery protection
- DC/DC conversion
- Power management
- Load switch

Features

- 5.4 A, 20 V $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 40 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$
- Extended V_{GSS} range (±8V) for battery applications
- High performance trench technology for extremely low R_{DS(ON)}
- Low profile TSSOP-8 package



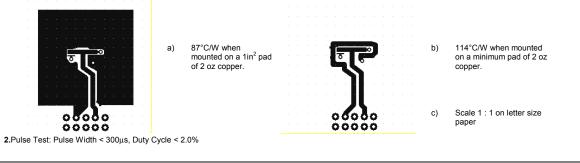


Absolute Maximum Ratings T_A=25°C unless otherwise noted

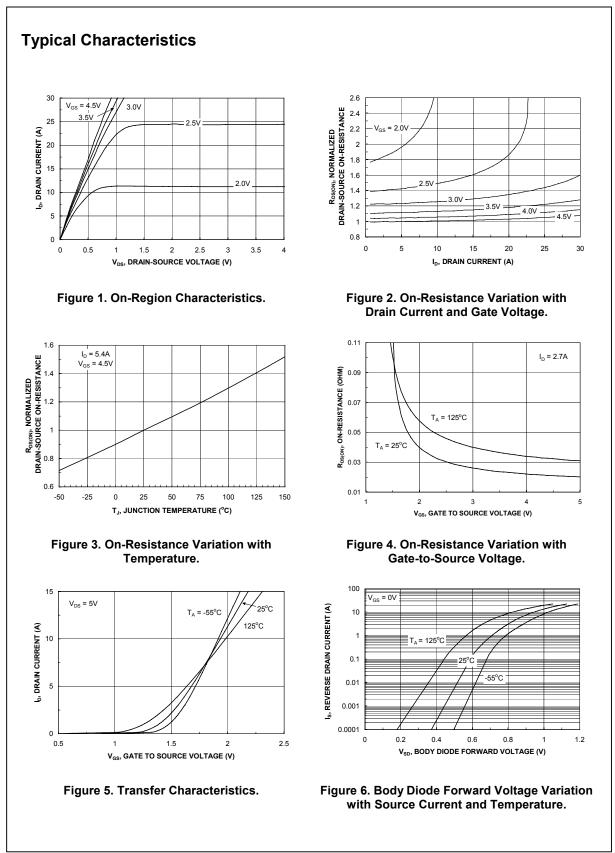
Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage	e Voltage		V
V _{GSS}	Gate-Source Voltage		± 8	
I _D	Drain Current – Continuous	(Note 1)	5.4	А
	– Pulsed		30	
PD	Power Dissipation	(Note 1a)	1.4	W
		(Note 1b)	1.1	
T _J , T _{STG}	Operating and Storage Junction Temper	ature Range	–55 to +150	۵°
Therma	Operating and Storage Junction Temper I Characteristics Thermal Resistance, Junction-to-Ambien	~	-55 to +150 87	
	I Characteristics	~		
Therma R _{0JA}	I Characteristics	t (Note 1a) (Note 1b)	87	°C °C/W
Therma _{RθJA} Packag	I Characteristics Thermal Resistance, Junction-to-Ambier e Marking and Ordering Inf	t (Note 1a) (Note 1b)	87	

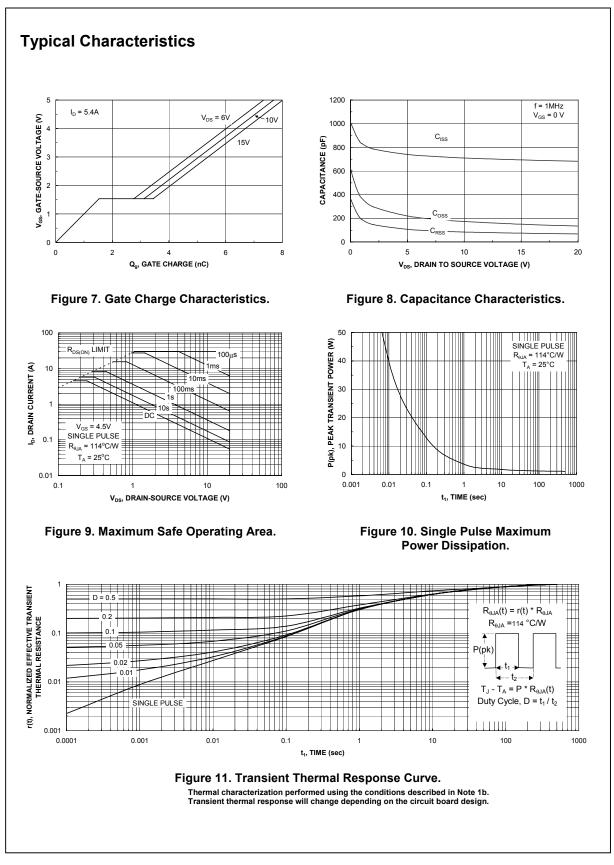
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 V$, $V_{GS} = 0 V$			1	μA
		V_{DS} = 20 V, V_{GS} = 0 V, T _J =55°C			5	
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	racteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.6	0.9	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			23 33	35 40	mΩ
I _{D(on)}	On–State Drain Current	$V_{GS} = 4.5 V$, $V_{DS} = 5 V$	20			А
		$V_{GS} = 2.5 V$, $V_{DS} = 5 V$	8			
g fs	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 5.4 A$		11		S
Dynamio	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		710		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		173		pF
C _{rss}	Reverse Transfer Capacitance			84		pF
Switchir	ng Characteristics (Note 2)				•	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 6 V$, $I_{D} = 1 A$,		7	14	ns
t _r	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$		17	31	ns
t _{d(off)}	Turn–Off Delay Time	-		16	29	ns
t _f	Turn–Off Fall Time	1		3	6	ns
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V$, $I_F = 1.5 A$, $dI_F/dt = 100A/\mu s$		14	100	ns
Qg	Total Gate Charge	$V_{DS} = 6 V$, $I_D = 5.4 A$,		7	10	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 4.5 V$		1.5		nC
Q _{gd}	Gate–Drain Charge			1.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings	•			
l _s	Maximum Continuous Drain–Source				1.25	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.25 A$ (Note 2)		0.7	1.2	V



Si6426DQ Rev B(W)





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Product selection and parametric search Cross-reference search technical information	for power management applications requiring a wide range of gate drive voltage ratings (2.5V to 8V).		Design tools
buy products	Features		
technical support			
my Fairchild company	• 5.4A, 20V $R_{DS(ON)} = 35m\Omega@V_{GS} = 4.5V$ $R_{DS(ON)} = 40m\Omega@V_{GS} = 2.5V$ • Extended V _{GSS} range (±8V) for battery applications	-	

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Applications

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Package marking	Packing method
SI6426DQ	Full Production	\$0.57	<u>TSSOP</u>	8	\$Y&3 6426	TAPE REEL

* 1,000 piece Budgetary Pricing

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